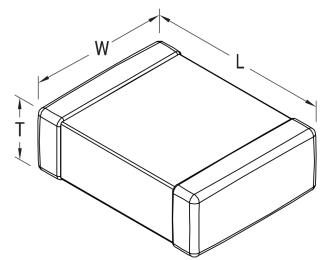


M123A13BXB474KZ-TR

Aliases (C2225Z474K5XAL7189)

SMD Mil PRF123, Ceramic, 0.47 uF, 10%, 50 VDC, BX, SMD Chip, Temperature Stable, N/A, 2225



Click here for the 3D model.

Chip Size 2225 L 5.588mm +/-0.381mm (0.22 in +/-0.015 in) W 6.35mm +/-0.381mm (0.25 in +/-0.015 in) T 1.778mm MAX (0.07 in MAX)	Dimensions	
W 6.35mm +/-0.381mm (0.25 in +/-0.015 in)	Chip Size	2225
	L	5.588mm +/-0.381mm (0.22 in +/-0.015 in)
T 1.778mm MAX (0.07 in MAX)	W	6.35mm +/-0.381mm (0.25 in +/-0.015 in)
	т	1.778mm MAX (0.07 in MAX)

Packaging Specifications			
Packaging	T&R, 180mm, Plastic Tape		
Packaging Quantity	2500		

General Information			
Series	SMD Mil PRF123		
Style	SMD Chip		
Description	SMD Chip, Temperature Stable		
RoHS	No		
Prop 65	A WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov.		
SCIP Number	8780fdfd-a0b3-4664-b80c-18c07cfab0d1		
Termination	Tin		
Failure Rate	N/A		
AEC-Q200	No		
Shelf Life	78 Weeks		
MSL	1		

Specifications			
Capacitance	0.47 uF		
Capacitance Tolerance	10%		
Voltage DC	50 VDC		
Dielectric Withstanding Voltage	125 VDC		
Temperature Range	-55/+125°C		
Temperature Coefficient	BX		
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vms		
Dissipation Factor	2.5%		
Insulation Resistance	100 GOhms		

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

单击下面可查看定价,库存,交付和生命周期等信息

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